

LOCTITE ABLESTIK QMI536HT

April 2014

0.0007

1×10¹³

3.4

PRODUCT DESCRIPTION

LOCTITE ABLESTIK QMI536HT provides the following product characteristics:

T 1 1	DA41/A		
Technology	BMI/Acrylate		
Appearance	Pink		
Filler Type	Boron Nitride		
Product Benefits	 Electrically non-conductive 		
	Hydrophobic		
	 Stable at high temperatures 		
	 Void-free bondline 		
	 Excellent interfacial adhesion strength 		
	 Good resistance to "popcorning" after 		
	exposure to reflow temperatures		
	 Excellent dielectric properties 		
Cure	Skip-Cure Process or Heat Cure		
Application	Die attach		
Typical Package	PBGA, Array packages, Tape packs and		
Application	CSP		
Typical Applications	Heat sinks, Heat slugs and Flip Chip		
Surface Finishes	Solder Mask, BT, FR, Au, Silicon, Polyimide		
	Kapton™, Palladium, Alloy 42 and Mylar™		

LOCTITE ABLESTIK QMI536HT die attach paste was designed to attach integrated circuits and components to advanced substrates.

TYPICAL PROPERTIES OF UNCURED MATERIAL

Viscosity @ 25 °C, mPa·s (cP):			
Speed 5 rpm	13,000		
Thixotropic Index (0.5/5 rpm)	5.5		
Specific Gravity @ 25°C	1.25		
Pot life @ 25 °C, hours	24		
Shelf Life @ -40°C, days	365		
Flash Point - See SDS			

TYPICAL CURING PERFORMANCE

Conventional Oven

15 minutes @ 150°C at bondline

Snap Cure Schedule

≥10 seconds @ 150°C at bondline

Tunnel Oven configured with hot gas or IR

≥10 seconds @ 150°C at bondline

SkipCure Process

≥8 seconds @ 150°C at bondline

The above cure profiles are guideline recommendations. Cure conditions (time and temperature) may vary based on customers' experience and their application requirements, as well as customer curing equipment, oven loading and actual oven temperatures.

TYPICAL PROPERTIES OF CURED MATERIAL

Physical Properties						
	Coefficient of Thermal Expansion , ppm/°C:					
	Below Tg		66			
	Above Tg		177			
	Glass Transition Temperature (Tg), °C		4			
	Coefficient of Thermal Conductivity, W/(m-K)		0.9			
	Tensile Modulus , @ 25°C	N/mm² (psi)	850 (123,250)			
	Extractable Ionic Content, ppm:					
	Sodium (Na+)		<20			
	Potassium (K+)		<20			
	Chloride (CI-)		<20			
	Fluoride (F-)		<20			
	Water Absorption wt., %:					
	168 hours @ 85°C/85 RH		< 0.35			

TYPICAL PERFORMANCE OF CURED MATERIAL

Alpha Particle Emissions, cts/cm2 /hr

Dielectric Constant @ 1 MHz, @ 25°C

Volume Resistivity, ohms-cm

Miscellaneous

Electrical Properties

Die Shear Strength @ 25 °C, kg-f: 0.635 x 0.635 mm, 0.254 mm BLT 17

GENERAL INFORMATION

For safe handling information on this product, consult the Material Safety Data Sheet, (MSDS).

Not for product specifications

The technical data contained herein are intended as reference only. Please contact your local quality department for assistance and recommendations on specifications for this product.

THAWING:

- 1. Allow container to reach room temperature before use.
- 2. After removing from the freezer, set the syringes to stand vertically while thawing.
- DO NOT open the container before contents reach 25°C temperature. Any moisture that collects on the thawed container should be removed prior to opening the container.
- DO NOT re-freeze. Once thawed to 25°C, the adhesive should not be re-frozen.



Directions for use Dispensing and Bondline Control:

- LOCTITE ABLESTIK QMI536HT adhesion is tested using 1 mil bondline thickness. Thinner bondlines increase stress and may affect adhesion.
- LOCTITE ABLESTIK QMI536HT has excellent rheology and flow easily under shear stresses such as those present during die bonding.
- 3. Optimization of die bonding parameters is strongly recommended to consistently meet target bondline thicknesses.

Storage

Store product in the unopened container in a dry location. Storage information may be indicated on the product container labeling.

Optimal Storage: -40 °C

Material removed from containers may be contaminated during use. Do not return product to the original container. Henkel Corporation cannot assume responsibility for product which has been contaminated or stored under conditions other than those previously indicated. If additional information is required, please contact your local Technical Service Center or Customer Service Representative.

Conversions

 $(^{\circ}C \times 1.8) + 32 = ^{\circ}F$ kV/mm x 25.4 = V/mil mm / 25.4 = inches N x 0.225 = lb N/mm x 5.71 = lb/in N/mm² x 145 = psi MPa = N/mm² MPa x 145 = psi N·m x 8.851 = lb·in N·m x 0.738 = lb·ft N·mm x 0.142 = oz·in mPa·s = cP

Disclaimer Note

The information provided in this Technical Data Sheet (TDS) including the recommendations for use and application of the product are based on our knowledge and experience of the product as at the date of this TDS. The product can have a variety of different applications as well as differing application and working conditions in your environment that are beyond our control. Henkel is, therefore, not liable for the suitability of our product for the production processes and conditions in respect of which you use them, as well as the intended applications and results. We strongly recommend that you carry out your own prior trials to confirm such suitability of our product.

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